



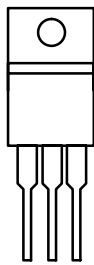
## N-Channel 40-V (D-S) 175°C MOSFET

## PRODUCT SUMMARY

| $V_{(BR)DSS}$ (V) | $r_{DS(on)}$ ( $\Omega$ ) | $I_D$ (A)       |
|-------------------|---------------------------|-----------------|
| 40                | 0.004 @ $V_{GS} = 10$ V   | 85 <sup>a</sup> |

**175°C Rated**  
Maximum Junction Temperature  
**TrenchFET<sup>®</sup>**  
Power MOSFETS

TO-220AB

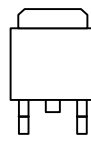
G D S  
Top View

Ordering Information

SUP85N04-04

SUP85N04-04—E3 (Lead (Pb)-Free)

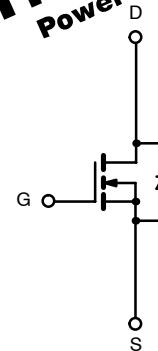
TO-263

G D S  
Top View

Ordering Information

SUP85N04-04

SUP85N04-04—E3 (Lead (Pb)-Free)



N-Channel MOSFET

www.DataSheet4U.com

ABSOLUTE MAXIMUM RATINGS ( $T_C = 25^\circ\text{C}$  UNLESS OTHERWISE NOTED)

| Parameter  | Symbol   | Limit                     | Unit   |                  |
|--|--|---------------------------|--|------------------|
| Drain-Source Voltage                                   | $V_{DS}$                                       | 40                        | V  |                  |
| Gate-Source Voltage                                    | $V_{GS}$                                       | 20                        |  |                  |
| Continuous Drain Current ( $T_J = 175^\circ\text{C}$ ) | $I_D$  | $T_C = 25^\circ\text{C}$  | 85 <sup>a</sup>                                | A                |
|  |  | $T_C = 125^\circ\text{C}$ | 85 <sup>a</sup>                                |                  |
| Pulsed Drain Current                                   | $I_{DM}$                                       | 240                       |  |                  |
| Avalanche Current                                      | $I_{AR}$                                       | 70                        |  |                  |
| Repetitive Avalanche Energy <sup>b</sup>               | $E_{AR}$                                       | L = 0.1 mH                | 211  | mJ               |
| Maximum Power Dissipation <sup>b</sup>                 |  |                           | $T_C = 25^\circ\text{C}$ (TO-220AB and TO-263) | 250 <sup>c</sup> |
|  | $T_A = 25^\circ\text{C}$ (TO-263) <sup>d</sup> | 3.75                      |  |                  |
| Operating Junction and Storage Temperature Range       | $T_J, T_{stg}$                                 | -55 to 175                | $^\circ\text{C}$                               |                  |

## THERMAL RESISTANCE RATINGS

| Parameter           | Symbol     | Limit                           | Unit |                    |
|---------------------|------------|---------------------------------|------|--------------------|
| Junction-to-Ambient | $R_{thJA}$ | PCB Mount (TO-263) <sup>d</sup> | 40   | $^\circ\text{C/W}$ |
|                     |            | Free Air (TO-220AB)             | 62.5 |                    |
| Junction-to-Case    | $R_{thJC}$ | 0.6                             |      |                    |

## Notes

- Package limited.
- Duty cycle  $\leq 1\%$ .
- See SOA curve for voltage derating.
- When mounted on 1" square PCB (FR-4 material).

## SUP/SUB85N04-04



Vishay Siliconix

| SPECIFICATIONS (T <sub>J</sub> = 25 °C UNLESS OTHERWISE NOTED)                            |                      |   |     |        |        |      |
|---|----------------------|---|-----|--------|--------|------|
| Parameter   | Symbol               | Test Condition  | Min | Typ    | Max    | Unit |
| <b>Static</b>   |                      |   |     |        |        |      |
| Drain-Source Breakdown Voltage  | V <sub>(BR)DSS</sub> | V <sub>DS</sub> = 0 V, I <sub>D</sub> = 250 μA  | 40  |        |        | V    |
| Gate-Threshold Voltage  | V <sub>GS(th)</sub>  | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA   | 2   |        | 4      |      |
| Gate-Body Leakage   | I <sub>GSS</sub>     | V <sub>DS</sub> = 0 V, V <sub>GS</sub> = 20 V   |     |        | 100    | nA   |
| Zero Gate Voltage Drain Current   | I <sub>DSS</sub>     | V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V   |     |        | 1      | μA   |
|   |                      | V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C  |     |        | 50     |      |
|   |                      | V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 175 °C  |     |        | 250    |      |
| On-State Drain Current <sup>a</sup>   | I <sub>D(on)</sub>   | V <sub>DS</sub> ≥ 5 V, V <sub>GS</sub> = 10 V   | 120 |        |        | A    |
| Drain-Source On-State Resistance <sup>a</sup>   | r <sub>DS(on)</sub>  | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 30 A   |     | 0.0031 | 0.004  | Ω    |
|   |                      | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 30 A, T <sub>J</sub> = 125 °C  |     |        | 0.0055 |      |
|   |                      | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 30 A, T <sub>J</sub> = 175 °C  |     |        | 0.007  |      |
| Forward Transconductance <sup>a</sup>   | g <sub>fs</sub>      | V <sub>DS</sub> = 15 V, I <sub>D</sub> = 30 A   | 30  |        |        | S    |
| <b>Dynamic<sup>b</sup></b>  |                      |   |     |        |        |      |
| Input Capacitance   | C <sub>iss</sub>     | V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 25 V, f = 1 MHz  |     | 7620   |        | pF   |
| Output Capacitance  | C <sub>oss</sub>     |   |     | 1325   |        |      |
| Reverse Transfer Capacitance  | C <sub>rss</sub>     |   |     | 710    |        |      |
| Total Gate Charge <sup>c</sup>  | Q <sub>g</sub>       | V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 85 A   |     | 160    | 250    | nC   |
| Gate-Source Charge <sup>c</sup>   | Q <sub>gs</sub>      |   |     | 40     |        |      |
| Gate-Drain Charge <sup>c</sup>  | Q <sub>gd</sub>      |   |     | 55     |        |      |
| Turn-On Delay Time <sup>c</sup>   | t <sub>d(on)</sub>   | V <sub>DD</sub> = 30 V, R <sub>L</sub> = 0.47 Ω<br>I <sub>D</sub> ≅ 85 A, V <sub>GEN</sub> = 10 V, R <sub>g</sub> = 2.5 Ω |     | 20     | 35     | ns   |
| Rise Time <sup>c</sup>  | t <sub>r</sub>       |   |     | 115    | 175    |      |
| Turn-Off Delay Time <sup>c</sup>  | t <sub>d(off)</sub>  |   |     | 75     | 115    |      |
| Fall Time <sup>c</sup>  | t <sub>f</sub>       |   |     | 85     | 130    |      |
| <b>Source-Drain Diode Ratings and Characteristics (T<sub>C</sub> = 25 °C)<sup>b</sup></b> |                      |   |     |        |        |      |
| Continuous Current  | I <sub>S</sub>       |   |     |        | 85     | A    |
| Pulsed Current  | I <sub>SM</sub>      |   |     |        | 240    |      |
| Forward Voltage <sup>a</sup>  | V <sub>SD</sub>      | I <sub>F</sub> = 85 A, V <sub>GS</sub> = 0 V  |     | 1.1    | 1.4    | V    |
| Reverse Recovery Time   | t <sub>rr</sub>      | I <sub>F</sub> = 85 A, di/dt = 100 A/μs   |     | 60     | 90     | ns   |
| Peak Reverse Recovery Current   | I <sub>RM(REC)</sub> |   |     | 2.6    | 4      | A    |
| Reverse Recovery Charge   | Q <sub>rr</sub>      |   |     | 0.08   | 0.15   | μC   |

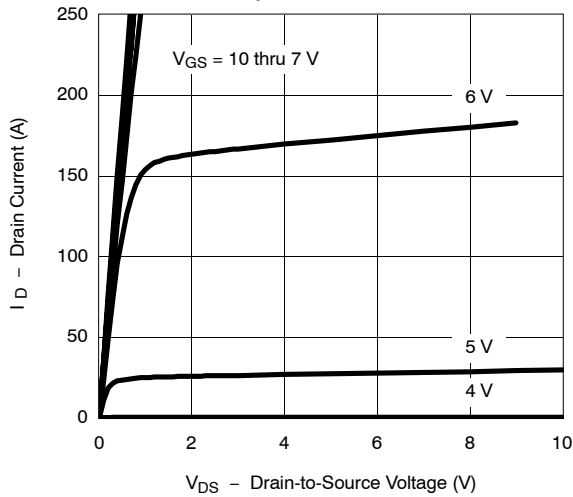
## Notes

- Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2%.
- Guaranteed by design, not subject to production testing.
- Independent of operating temperature.

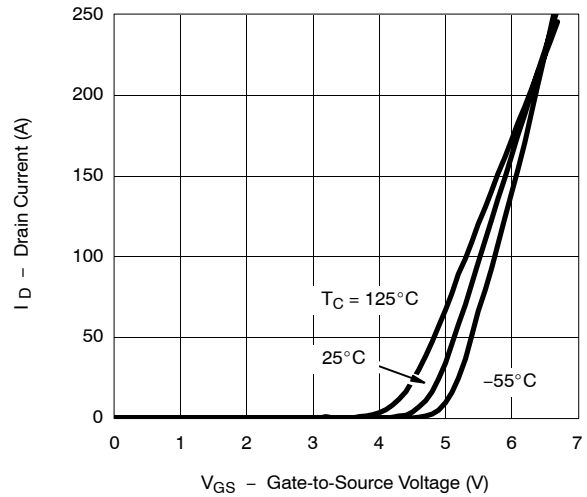


**TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)**

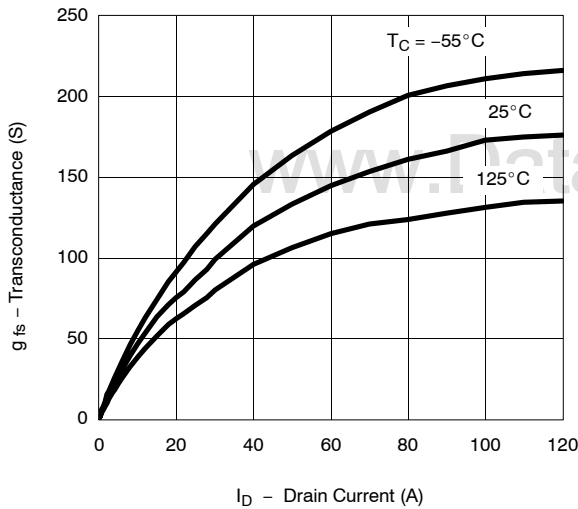
**Output Characteristics**



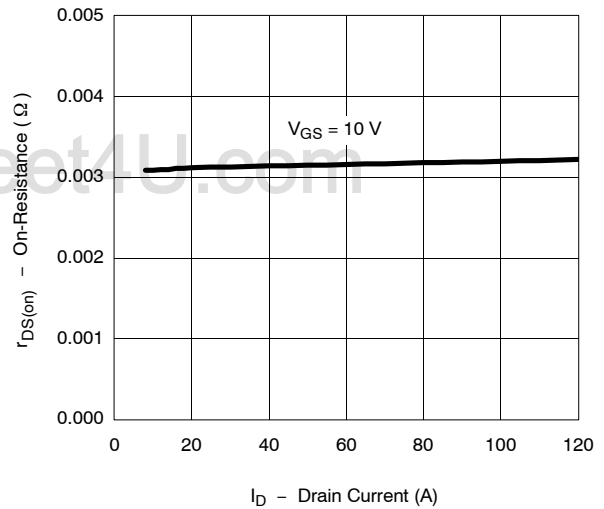
**Transfer Characteristics**



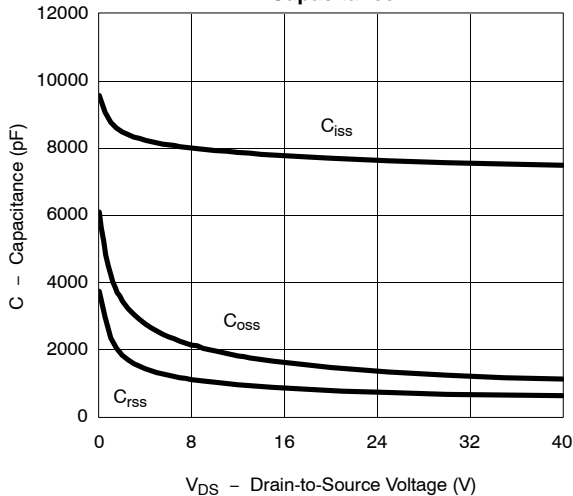
**Transconductance**



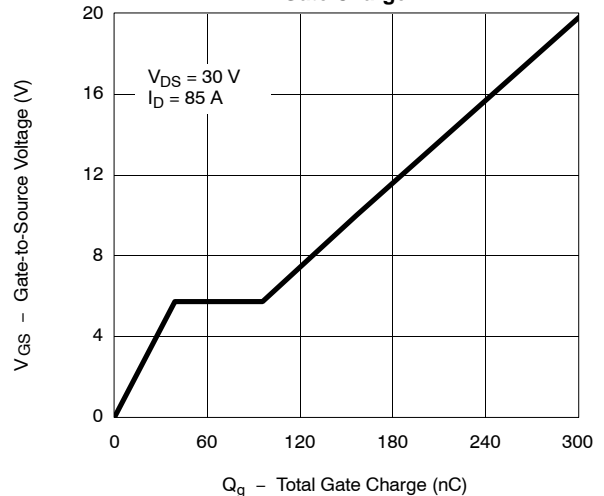
**On-Resistance vs. Drain Current**



**Capacitance**



**Gate Charge**

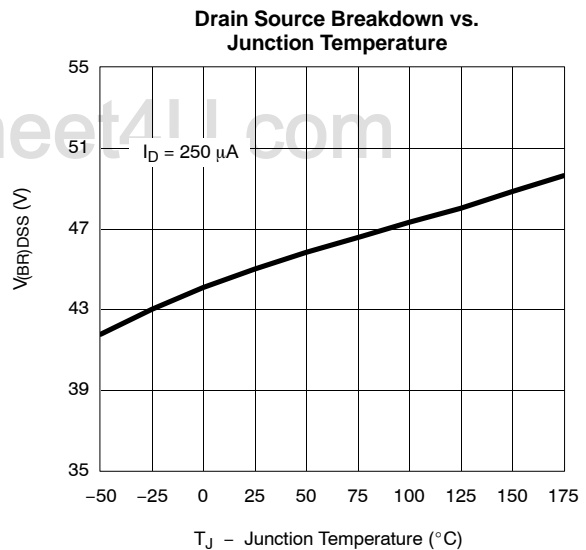
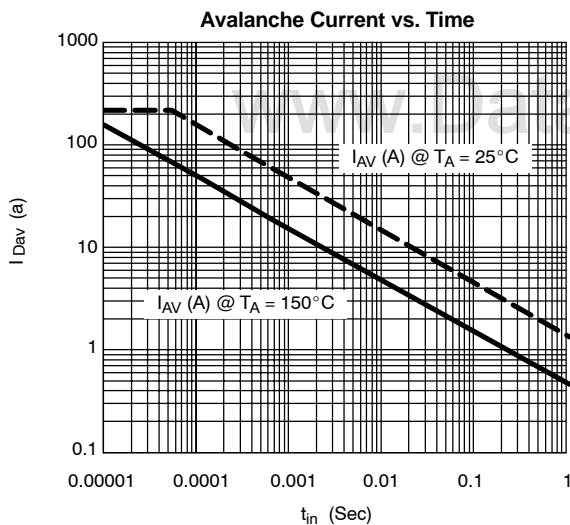
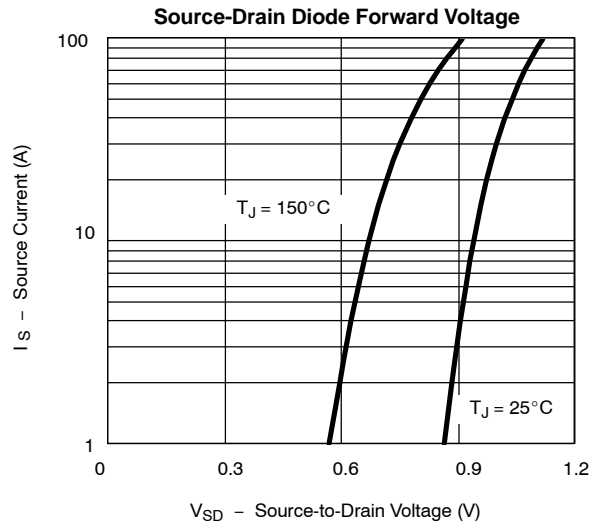
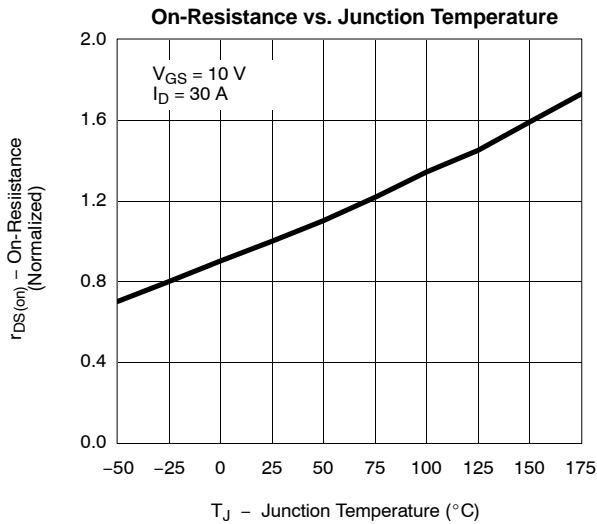


# SUP/SUB85N04-04

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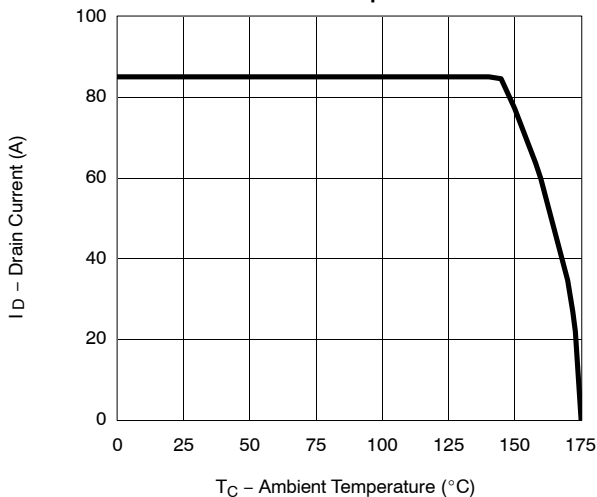
## TYPICAL CHARACTERISTICS (25 °C UNLESS NOTED)



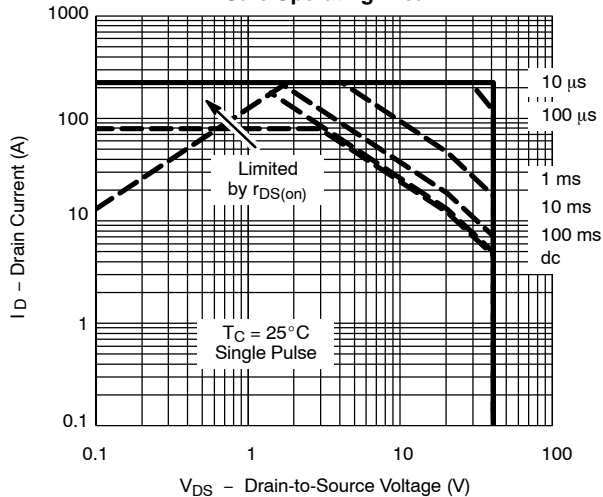


**THERMAL RATINGS**

**Maximum Avalanche and Drain Current vs. Case Temperature**



**Safe Operating Area**



**Normalized Thermal Transient Impedance, Junction-to-Case**

